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December 2015



N-Channel SuperFET[®] II MOSFET

800 V, 10 A, 650 m Ω

Features

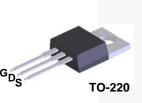
- R_{DS(on)} = 530 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 27 nC)
- Low E_{oss} (Typ. 2.8 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 124 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

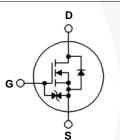
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

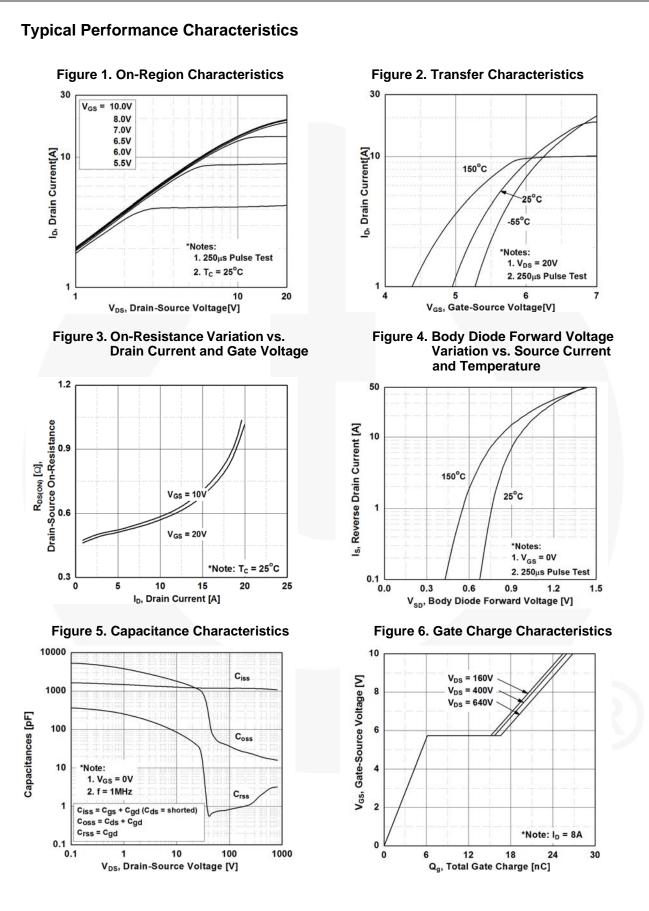
Symbol		FCP650N80Z	Unit			
V _{DSS}	Drain to Source Voltage		800	V		
V _{GSS}		- DC	- DC			
	Gate to Source Voltage	- AC	- AC (f > 1 Hz)			
	Drain Current	- Continuous ($T_C = 25^{\circ}C$)	10	Α		
I _D	Drain Current	- Continuous ($T_C = 100^{\circ}C$)		6.3	- A	
I _{DM}	Drain Current	- Pulsed	d (Note 1) 24			
E _{AS}	Single Pulsed Avalanche Ene	(Note 2)	204	mJ		
I _{AR}	Avalanche Current	(Note 1)	1.6	Α		
E _{AR}	Repetitive Avalanche Energy			1.62	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt	20				
D	Dower Dissinction	$(T_{C} = 25^{\circ}C)$	$(T_{\rm C} = 25^{\rm o}{\rm C})$			
PD	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C			
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

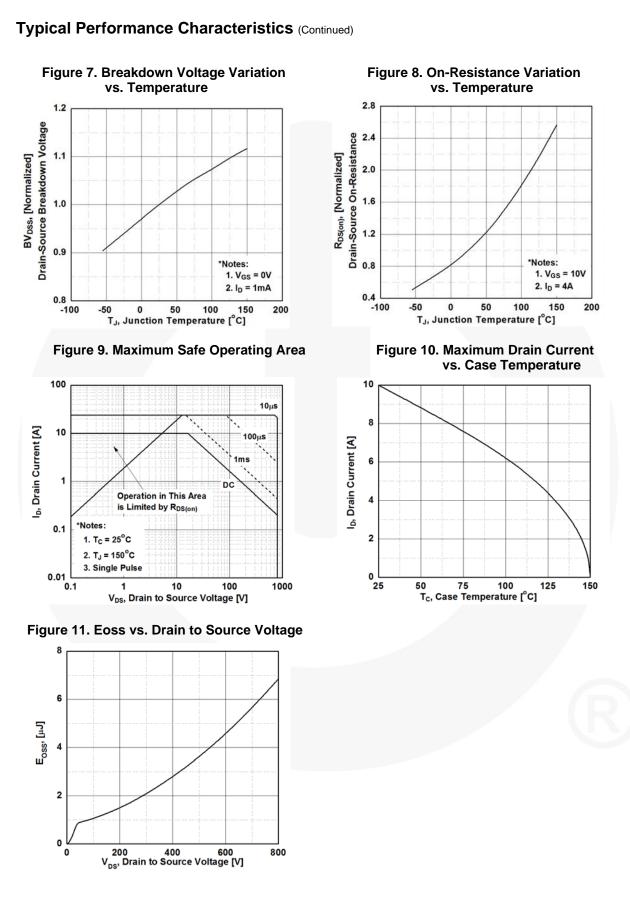
Symbol	Parameter	FCP650N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.77	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

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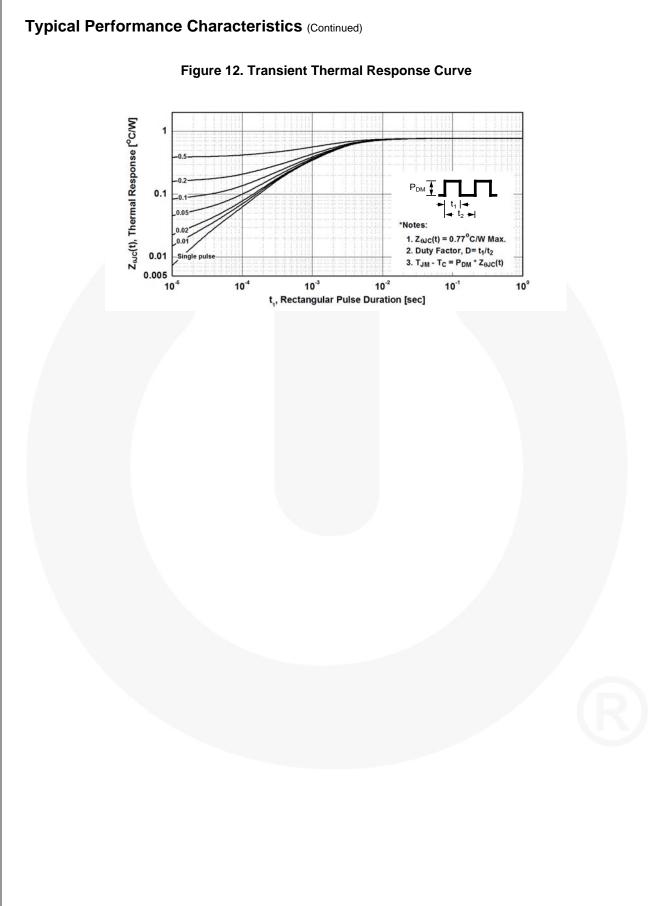
Part Nur			Pack	ckage Packing Method Reel Si		ze	Tape Widt	th Q	Quantity		
FCP650			TO-	D-220 Tube N/A			N/A		N/A	5	0 units
Electrica	l Char	acteristics To = 2	25°C unle	ss oth	erwise noted						
Symbol	al Characteristics T _C = 25°C un Parameter			Test Conditions				Min.	Тур.	Max.	Unit
Off Charac	toristic	6							•	1	
					01/1 1	• T	2500	000	-	-	
BV _{DSS} ΔBV _{DSS}		Source Breakdown Vol		$V_{GS} = 0 V, I_D = 1 mA, T_J = 25^{\circ}C$			800	-	-	V	
ΔΒν _{DSS} / ΔΤ _J	Coeffici	0 1		$I_D = 1 \text{ mA}, \text{ Referenced to } 25^{\circ}\text{C}$			-	0.8	-	V/ºC	
I _{DSS}	Zero Gate Voltage Drain Current		דר ⊢	V _{DS} = 800 V, V _{GS} = 0 V				-	-	25	μA
				$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$			-	-	250	· ·	
I _{GSS}	Gate to	Body Leakage Current		V _{GS} =	±20 V, V _{DS} =	= 0 V		-	-	±10	μA
On Charac	teristic	S									
V _{GS(th)}	Gate Th	reshold Voltage		V _{GS} =	V _{DS} , I _D = 0.8	mA		2.5	-	4.5	V
R _{DS(on)}		rain to Source On Resis		$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$		-	530	650	mΩ		
9FS	Forward	d Transconductance			20 V, I _D = 4 /			-	7.8	-	S
Dynamic C	`haracte	aristics									1
C _{iss}		apacitance						<u>.</u>	1178	1565	pF
C _{ISS}	-	Capacitance		─ V _{DS} = 100 V, V _{GS} = 0 V, _ f = 1 MHz		-	36	48	pF		
C _{rss}		e Transfer Capacitance					0.84	-	pF		
C _{oss}		Capacitance		Vpo =	480 V, V _{GS} =	= 0 V f =	1 MHz	-	18	-	pF
C _{oss (eff.)}	· ·	e Output Capacitance		-	0 V to 480 V			-	124	-	pF
Q _{g(tot)}		ate Charge at 10V					, v	-	27	35	nC
Q_{gs}		Source Gate Charge		$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 8 \text{ A},$ $V_{GS} = 10 \text{ V}$		-	6	-	nC		
Q _{gd}		Drain "Miller" Charge		63			(Note 4)	-	11	-	nC
ESR		ent Series Resistance		f = 1 N	IHz			-	1.9	-	Ω
<u>Switching</u>											
Switching									17	44	
t _{d(on)}		n Delay Time n Rise Time		Van -	400 V In = 8	Δ	-	-	17	44	ns
t _r		f Delay Time		$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 8 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$		-		40	32 90	ns	
t _{d(off)}		f Fall Time					3.4	17	ns		
t _f							(Note 4)	-	5.4	17	ns
		le Characteristics		ada Er		- 4				10	•
l _S			ain to Source Diode Forward Current					-	-	10 24	A
I _{SM}						٨		-	-	1.2	V
V _{SD}		Source Diode Forward	vollage		-				365	-	-
t _{rr}		Recovery Charge			0 V, I _{SD} = 8 = 100 A/μs	А,	-		5.9	-	ns µC
Q _{rr} Notes:	itevel se	incovery ondrye			.007740			-	5.9		μΟ
	: pulse width	limited by maximum junction ter	nperature.								
2. I _{AS} = 1.6 A, R _G											
		$V_{DD} \le BV_{DSS}$, Starting T _J = 25°C erating temperature typical char									



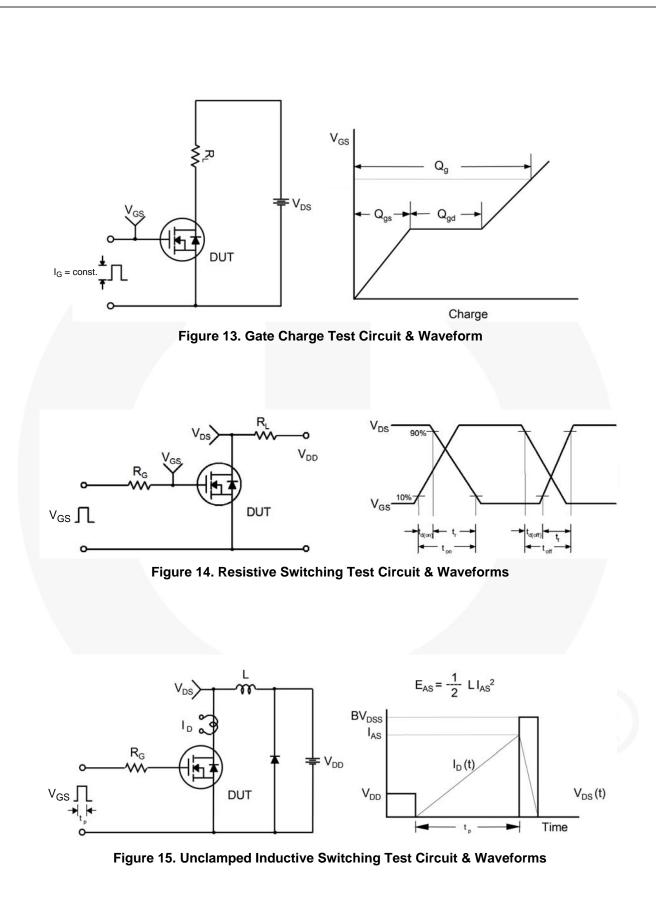
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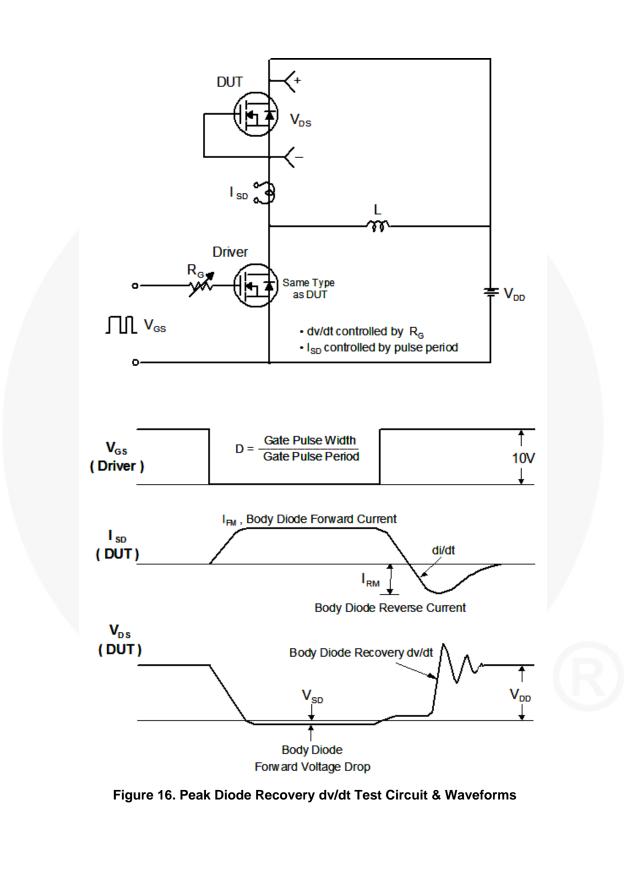


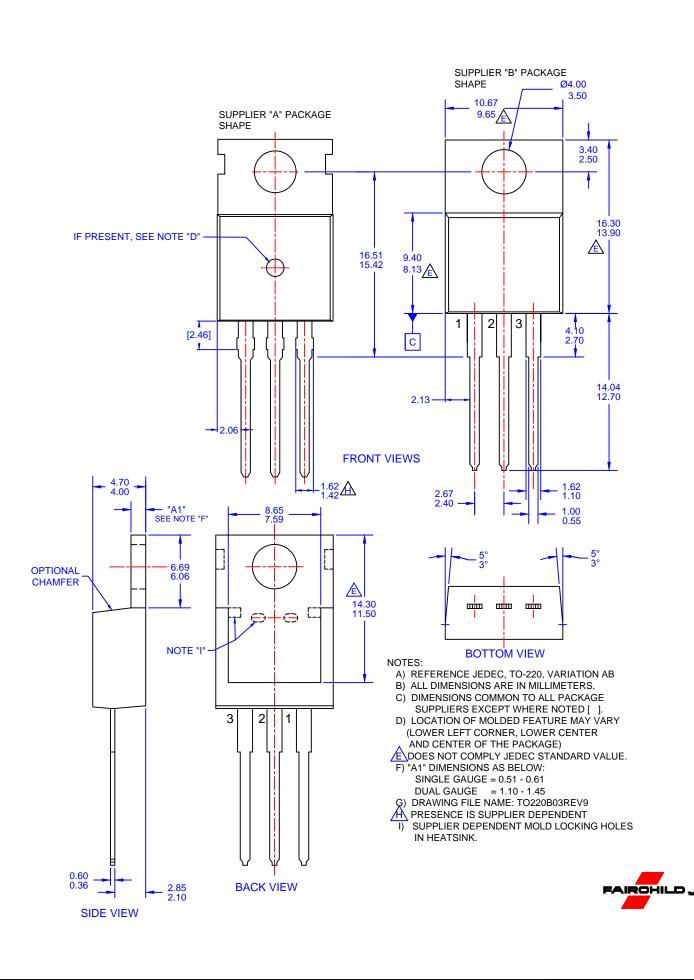
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